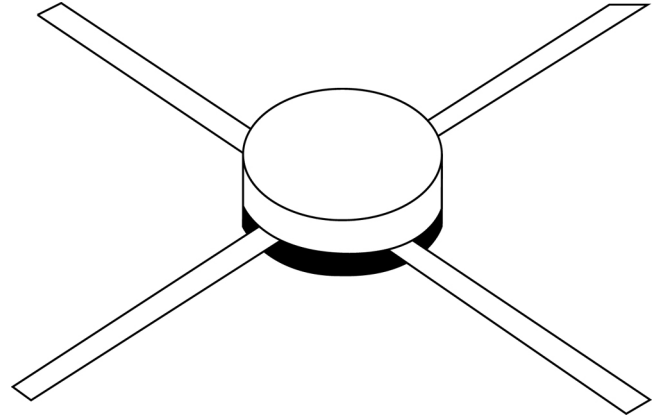


## NPN LOW NOISE SILICON MICROWAVE TRANSISTOR

### PRODUCT DATA SHEET

#### FEATURES:

- Common Base
- High Gain Bandwidth Product  
 $f_t = 10 \text{ GHz typ @ } I_C = 25\text{mA}$
- High Gain  
 $|S_{21}|^2 = 7.10 \text{ dB @ } 1.0 \text{ GHz}$   
 $5.60 \text{ dB @ } 2.0 \text{ GHz}$
- High Reliability  
 Gold Metallization  
 Nitride Passivation
- Low Cost
- Ceramic Micro-X package available



#### Absolute Maximum Ratings:

SYMBOL	PARAMETERS	RATING	UNITS
$V_{CBO}$	Collector-Base Voltage	20	V
$V_{CEO}$	Collector-Emitter Voltage	12	V
$V_{EBO}$	Emitter-Base Voltage	1.5	V
$I_C$	Collector Current	60	mA
$T_J$	Junction Temperature	200	°C
$T_{STG}$	Storage Temperature	-65 to 150	°C

#### PERFORMANCE DATA:

- Electrical Characteristics ( $T_A = 25^\circ\text{C}$ )

SYMBOL	PARAMETERS & CONDITIONS <small><math>V_{CE} = 8\text{V}, I_C = 25 \text{ mA}</math> unless stated</small>	UNIT	MIN.	TYP.	MAX.
$f_t$	Gain Bandwidth Product	GHz		10.0	
$ S_{21} ^2$	Insertion Power Gain: $f = 1.0 \text{ GHz}$ $f = 2.0 \text{ GHz}$	dB dB		7.10 5.60	
$P_{1\text{dB}}$	Power output at 1dB compression: $f = 1.0 \text{ GHz}$	dBm		21.0	
$G_{1\text{dB}}$	Gain at 1dB compression: $f = 1.0 \text{ GHz}$	dBm		15.0	
$h_{FE}$	Forward Current Transfer Ratio: $V_{CE} = 8\text{V}, I_C = 25 \text{ mA}$		30	150	300
$I_{CBO}$	Collector Cutoff Current : $V_{CB} = 8\text{V}$	$\mu\text{A}$			0.2
$I_{EBO}$	Emitter Cutoff Current : $V_{EB} = 1\text{V}$	$\mu\text{A}$			1.0
$C_{CB}$	Collector Base Capacitance: $V_{CB} = 8\text{V}$ $f = 1\text{MHz}$	pF		0.25	